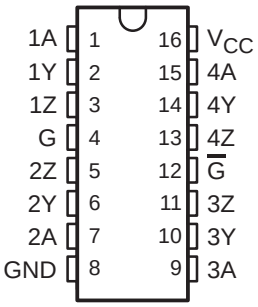
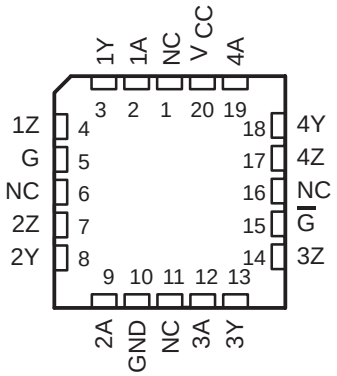
- **Meets or Exceeds the Requirements of ANSI Standard EIA/TIA-422-B and ITU Recommendation V.11**
- **Designed to Operate Up to 20 Mbaud**
- **3-State TTL Compatible**
- **Single 5-V Supply Operation**
- **High Output Impedance in Power-Off Condition**
- **Complementary Output Enable Inputs**
- **Improved Replacement for the AM26LS31**

SN55ALS192 . . . J OR W PACKAGE
SN75ALS192 . . . D OR N PACKAGE
(TOP VIEW)



SN55ALS192 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description

These four differential line drivers are designed for data transmission over twisted-pair or parallel-wire transmission lines. They meet the requirements of ANSI Standard EIA/TIA-422-B and ITU Recommendations V.11 and are compatible with 3-state TTL circuits. Advanced low-power Schottky technology provides high speed without the usual power penalties. Standby supply current is typically only 26 mA, while typical propagation delay time is less than 10 ns.

High-impedance inputs maintain low input currents, less than 1 μA for a high level and less than 100 μA for a low level. Complementary enable inputs, G and $\overline{G}$, allow these devices to be enabled at either a high input level or low input level. The SN75ALS192 is capable of data rates in excess of 20 megabits per second and is designed to operate with the SN75ALS193 quadruple line receiver. The SN55ALS192 is also capable of data rates in excess of 20 megabits per second and designed to operate with the SN55ALS193; however, it may be limited to a lower bit rate based on the temperature (refer to the dissipation rating table and Figure 15).

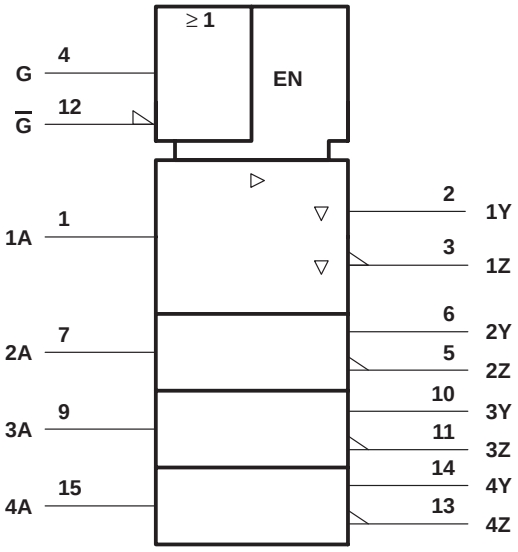
The SN55ALS192 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN75ALS192 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE
(each driver)

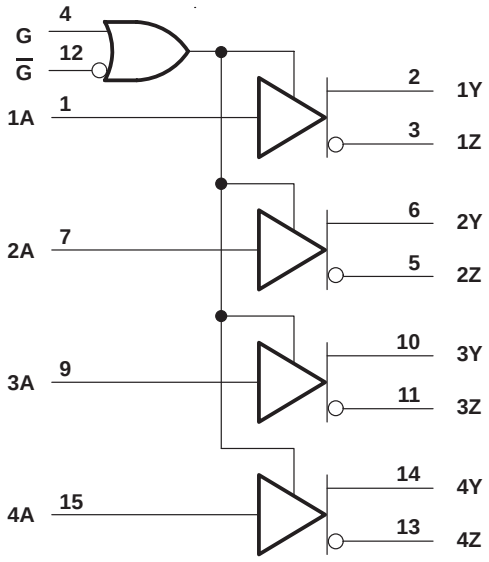
INPUT	ENABLES		OUTPUTS	
A	G	$\overline{G}$	Y	$\overline{Z}$
H	H	X	H	L
L	H	X	L	H
H	X	L	H	L
L	X	L	L	H
X	L	H	Z	Z

H = high level, L = low level,
Z = high impedance (off), X = irrelevant

logic symbol†

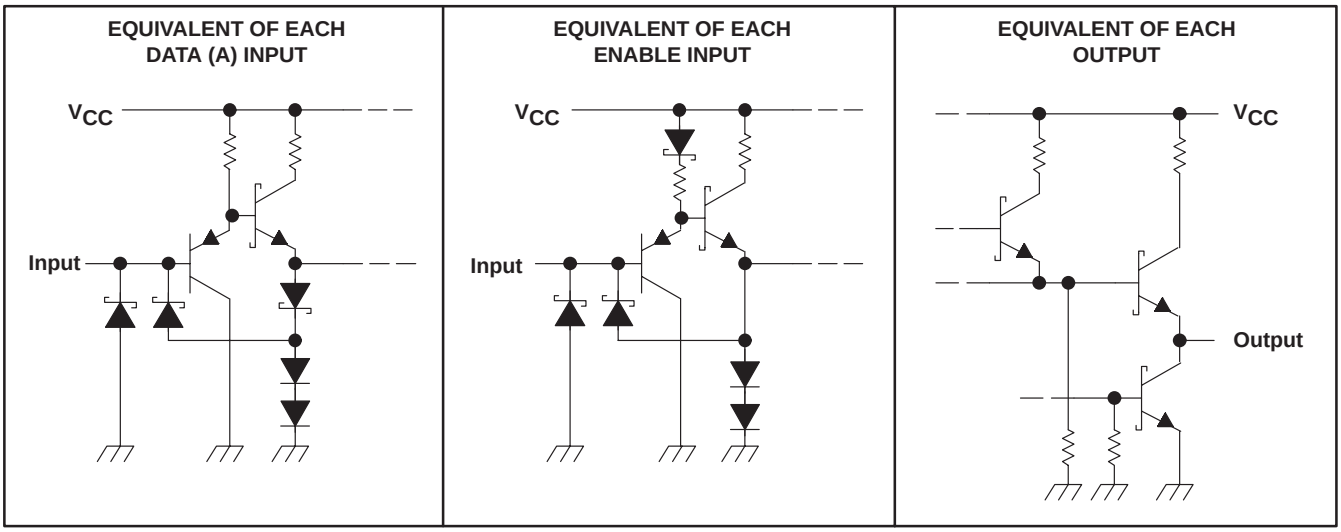


logic diagram (positive logic)



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, J, N, and W packages.

schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage, V_I . . . . . 7 V
Off-state output voltage . . . . . 6 V
Continuous total dissipation . . . . . See Dissipation Rating Table
Operating free-air temperature range, T_A: SN55ALS192 . . . . . – 55°C to 125°C
SN75ALS192 . . . . . 0°C to 70°C
Storage temperature range, T_{stg} . . . . . – 65°C to 150°C
Case temperature for 60 seconds, T_C: FK package . . . . . 260°C
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds: J package . . . . . 300°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D, N, or W package . . . . . 260°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values except differential output voltage, V_{OD}, are with respect to network ground terminal.

DISSIPATION RATING TABLE

PACKAGE	$T_A \le 25°C$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25°C$	$T_A = 70°C$ POWER RATING	$T_A = 125°C$ POWER RATING
D	950 mW	7.6 mW/°C	608 mW	N/A
FK	1375 mW	11.0 mW/°C	880 mW	275 mW
J†	1375 mW	11.0 mW/°C	880 mW	275 mW
N	1150 mW	9.2 mW/°C	736 mW	N/A
W	1000 mW	8.0 mW/°C	640 mW	200 mW

† In the J package, the SN55ALS192 chips are either alloy or silver glass mounted.

recommended operating conditions

	SN55ALS192			SN75ALS192			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.5	5	5.5	4.75	5	5.25	V
High level input voltage, V_{IH}	2			2			V
Low-level input voltage, V_{IL}			0.8			0.8	V
High-level output current, I_{OH}			– 20			– 20	mA
Low-level output current, I_{OL}			20			20	mA
Operating free-air temperature, T_A	– 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		SN55ALS192			SN75ALS192			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	Input clamp voltage	V_{CC} = MIN,	I_I = –18 mA			–1.5			–1.5	V
V_{OH}	High-level output voltage	V_{CC} = MIN,	I_{OH} = – 20 mA	2.4			2.5			V
V_{OL}	Low-level output voltage	V_{CC} = MIN,	I_{OL} = 20 mA			0.5			0.5	V
V_O	Output voltage	V_{CC} = MAX,	I_O = 0	0		6	0		6	V
$\|V_{OD1}\|$	Differential output voltage	V_{CC} = MIN,	I_O = 0	1.5		6	1.5		6	V
$\|V_{OD2}\|$	Differential output voltage	R_L = 100 Ω,	See Figure 1	1/2 V_{OD1} or 2§			1/2 V_{OD1} or 2§			V
$\Delta\|V_{OD}\|$	Change in magnitude of differential output voltage¶	R_L = 100 Ω,	See Figure 1			± 0.2			± 0.2	V
V_{OC}	Common-mode output voltage#					± 3			± 3	V
$\Delta\|V_{OC}\|$	Change in magnitude of common-mode output voltage¶					± 0.2			± 0.2	V
I_O	Output current with power off	V_{CC} = 0	V_O = 6 V			100			100	µA
			V_O = – 0.25 V			–100			–100	
I_{OZ}	Off-state (high-impedance state) output current	V_{CC} = MAX	V_O = 0.5 V			–20			–20	µA
			V_O = 2.5 V			20			20	
I_I	Input current at maximum input voltage	V_{CC} = MAX,	V_I = 7 V			100			100	µA
I_{IH}	High-level input current	V_{CC} = MAX,	V_I = 2.7 V			20			20	µA
I_{IL}	Low-level input current	V_{CC} = MAX,	V_I = 0.4 V			– 200			– 200	µA
I_{OS}	Short-circuit output current‖	V_{CC} = MAX		– 30		–150	– 30		– 150	mA
I_{CC}	Supply current (all drivers)	V_{CC} = MAX, All outputs disabled			26	45		26	45	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V and T_A = 25°C.
§ The minimum V_{OD2} with a 100-Ω load is either 1/2 V_{OD1} or 2 V, whichever is greater.
¶ | V_{OD} | and | V_{OC} | are the changes in magnitude of V_{OD} and V_{OC}, respectively, that occur when the input is changed from a high level to a low level.
# In ANSI Standard EIA/TIA-422-B, V_{OC}, which is the average of the two output voltages with respect to ground, is called output offset voltage, V_{OS}.
‖ Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 2)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high-level output	S1 and S2 open,	C_L = 30 pF		6	13	ns
t_{PHL}	Propagation delay time, high-to-low-level output				9	14	ns
	Output-to-output skew				3	6	ns
t_{PZH}	Output enable time to high level	S1 open and S2 closed			11	15	ns
t_{PZL}	Output enable time to low level	S1 closed and S2 open			16	20	ns
t_{PHZ}	Output disable time from high level	S1 open and S2 closed,	C_L = 10 pF		8	15	ns
t_{PLZ}	Output disable time from low level	S1 and S2 closed,	C_L = 10 pF		18	20	ns

PARAMETER MEASUREMENT INFORMATION

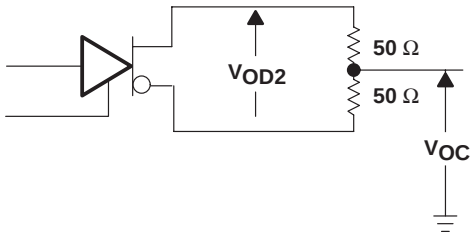
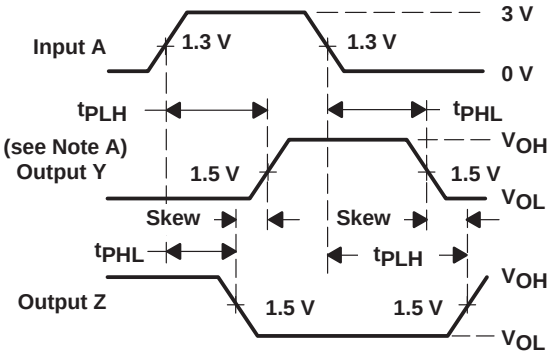
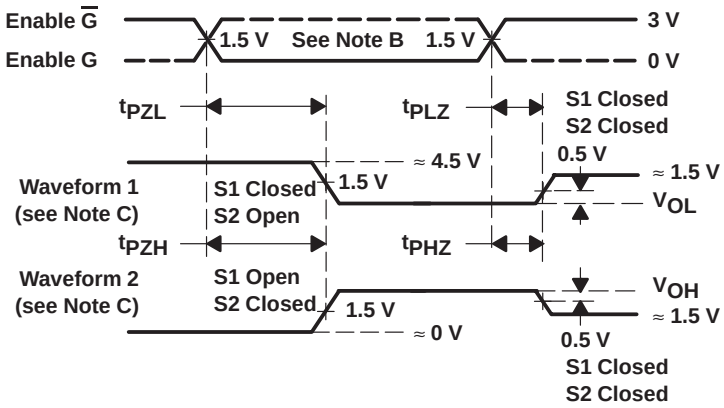


Figure 1. Differential and Common-Mode Output Voltages

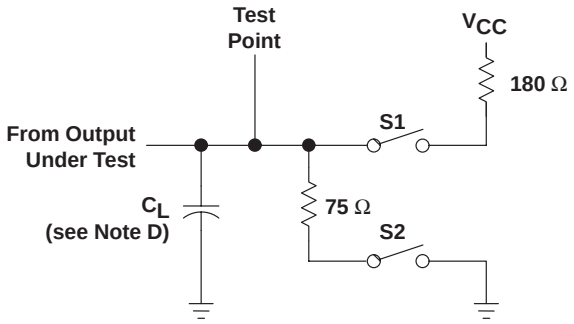


PROPAGATION DELAY TIMES AND SKEW



ENABLE AND DISABLE TIMES

VOLTAGE WAVEFORMS



TEST CIRCUIT

NOTES: A. When measuring propagation delay times and skew, switches S1 and S2 are open.
B. Each enable is tested separately.
C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
D. C_L includes probe and jig capacitance.
E. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, $Z_O \approx 50\ \Omega$, $t_r \le 15$ ns, and $t_f \le 6$ ns.

Figure 2. Test Circuit and Voltage Waveforms

TYPICAL CHARACTERISTICS†

Y OUTPUT VOLTAGE vs DATA INPUT VOLTAGE

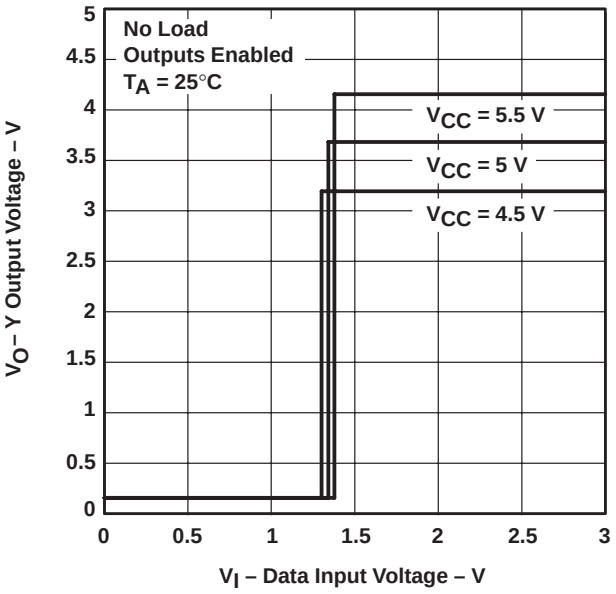


Figure 3

Y OUTPUT VOLTAGE vs DATA INPUT VOLTAGE

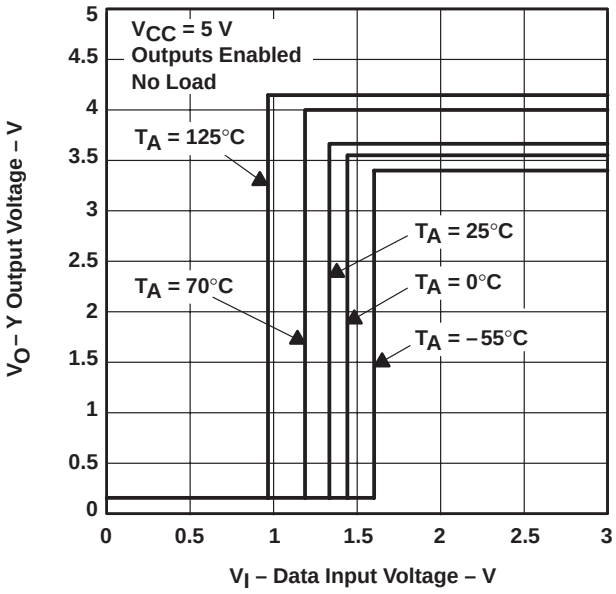


Figure 4

Y OUTPUT VOLTAGE vs ENABLE G INPUT VOLTAGE

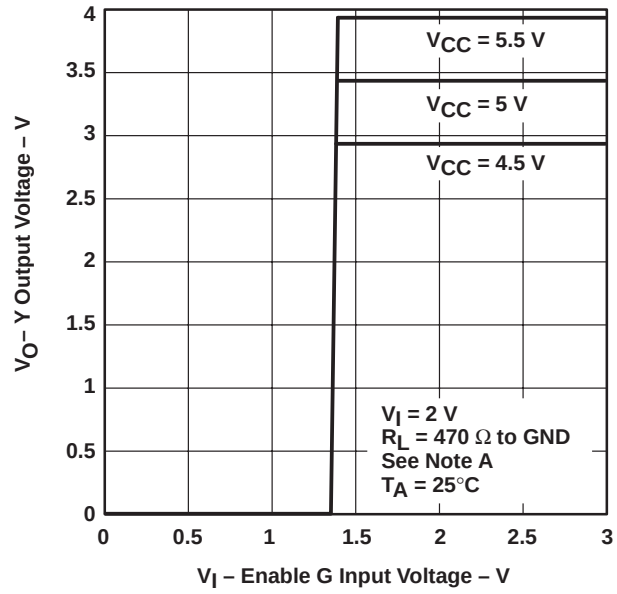


Figure 5

Y OUTPUT VOLTAGE vs ENABLE G INPUT VOLTAGE

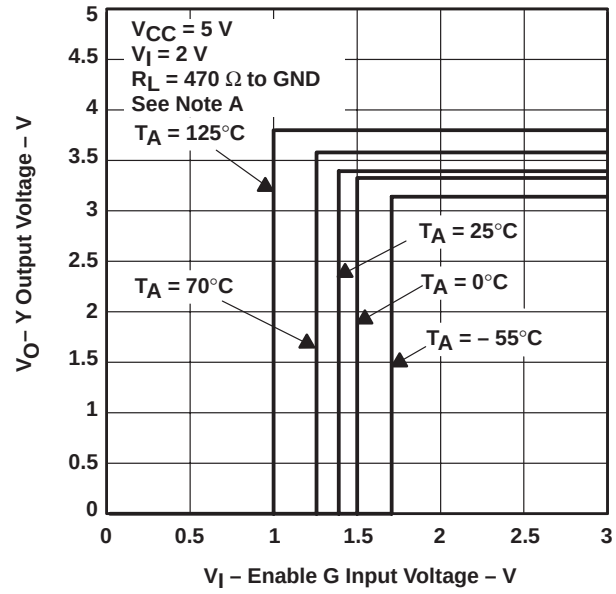


Figure 6

NOTE A: The A input is connected to V_{CC} during the testing of the Y outputs and to ground during the testing of the Z outputs.

† Data for temperatures below 0°C and above 70°C and below 4.75 V and above 5.25 V are applicable to SN55ALS192 circuits only.

TYPICAL CHARACTERISTICS†

Z OUTPUT VOLTAGE vs ENABLE G INPUT VOLTAGE

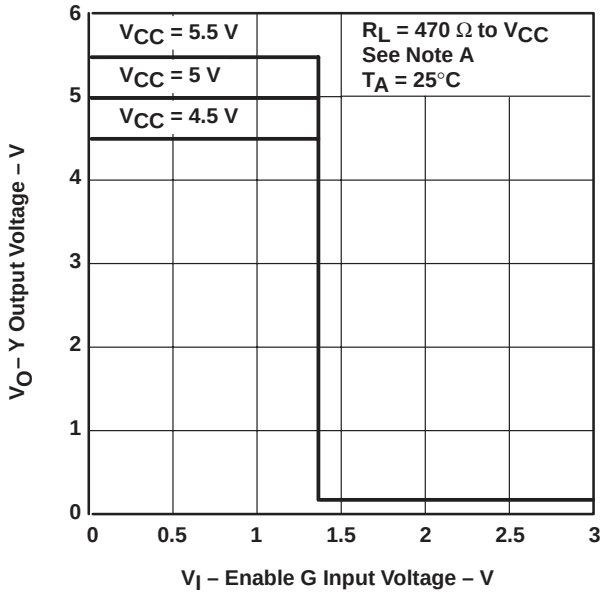


Figure 7

Z OUTPUT VOLTAGE vs ENABLE G INPUT VOLTAGE

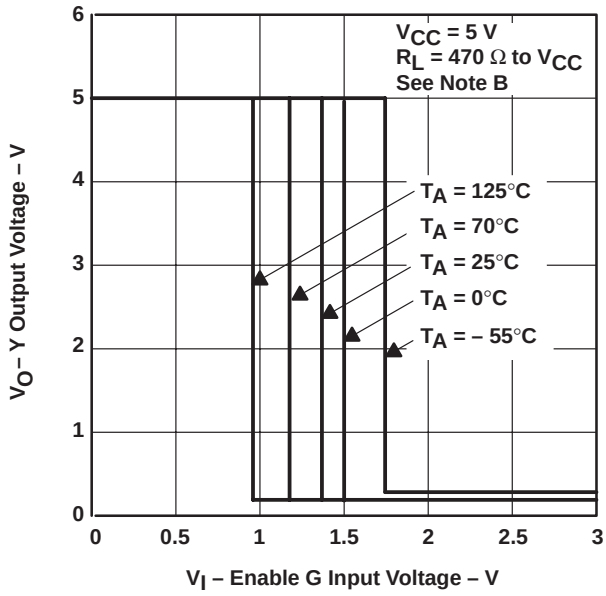


Figure 8

HIGH-LEVEL OUTPUT VOLTAGE vs FREE-AIR TEMPERATURE

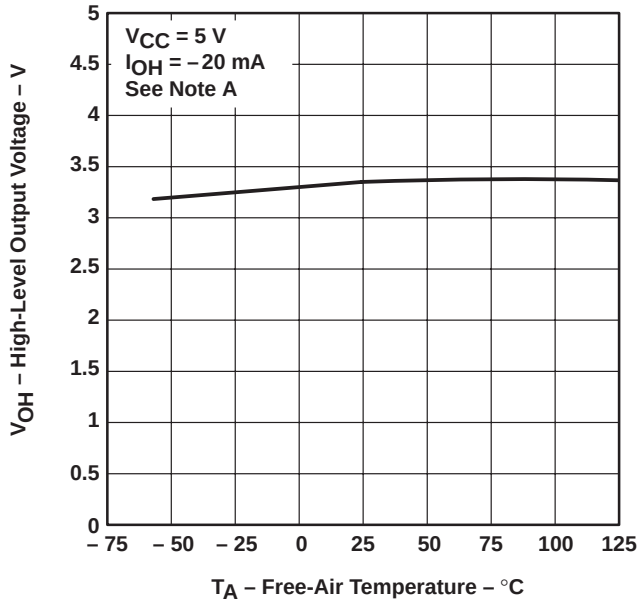


Figure 9

HIGH-LEVEL OUTPUT VOLTAGE vs OUTPUT CURRENT

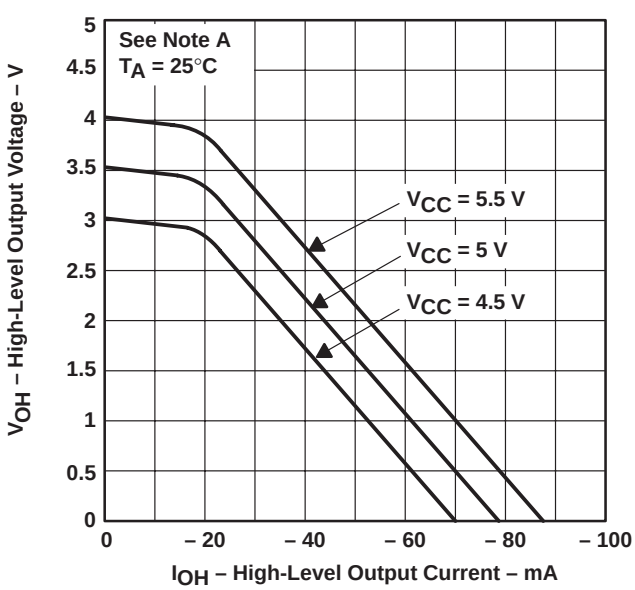


Figure 10

† Data for temperatures below 0°C and above 70°C, and below 4.75 V and above 5.25 V, are applicable to SN55ALS192 circuits only.

NOTES: A. The A input is connected to V_{CC} during the testing of the Y outputs and to ground during the testing of the Z outputs.
B. The A input is connected to GND during the testing of the Y outputs and to V_{CC} during the testing of the Z outputs.

TYPICAL CHARACTERISTICS†

LOW-LEVEL OUTPUT VOLTAGE vs FREE-AIR TEMPERATURE

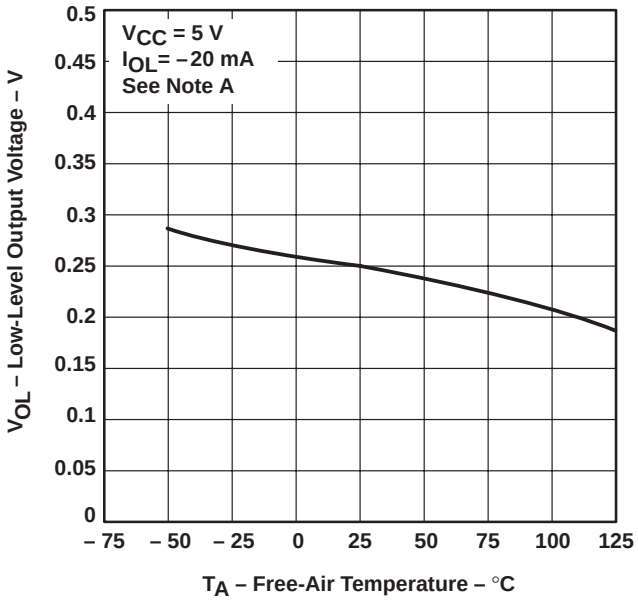


Figure 11

LOW-LEVEL OUTPUT VOLTAGE vs LOW-LEVEL OUTPUT CURRENT

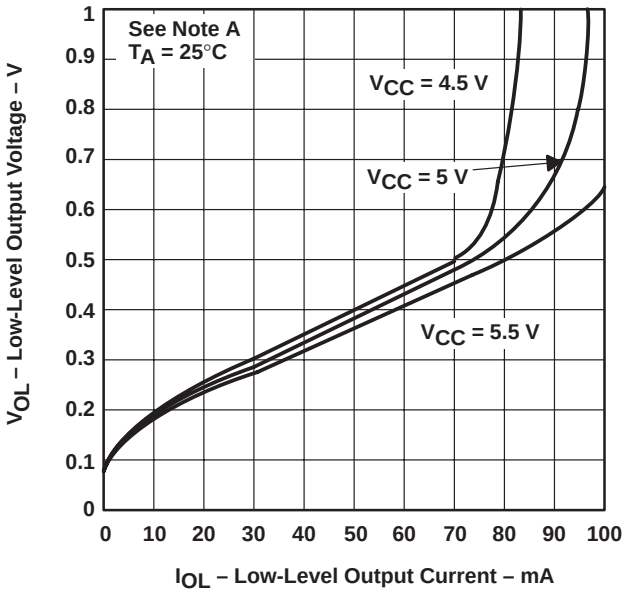


Figure 12

NOTE A: The A input is connected to GND during the testing of the Y outputs and to V_{CC} during the testing of the Z outputs.

SUPPLY CURRENT vs SUPPLY VOLTAGE

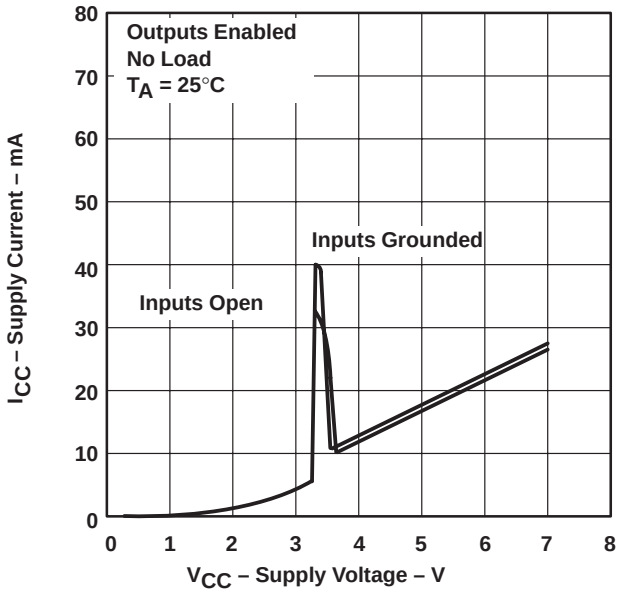


Figure 13

SUPPLY CURRENT vs SUPPLY VOLTAGE

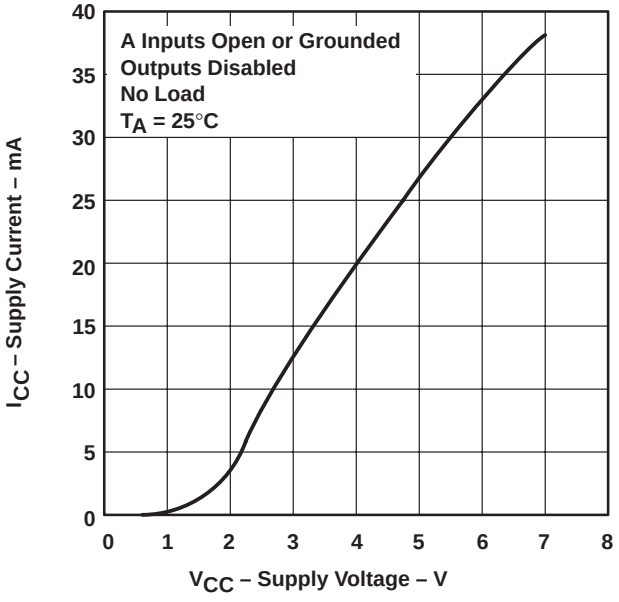


Figure 14

† Data for temperatures below 0°C and above 70°C, and below 4.75 V and above 5.25 V, are applicable to SN55ALS192 circuits only.

TYPICAL CHARACTERISTICS

**SUPPLY CURRENT
vs
FREQUENCY**

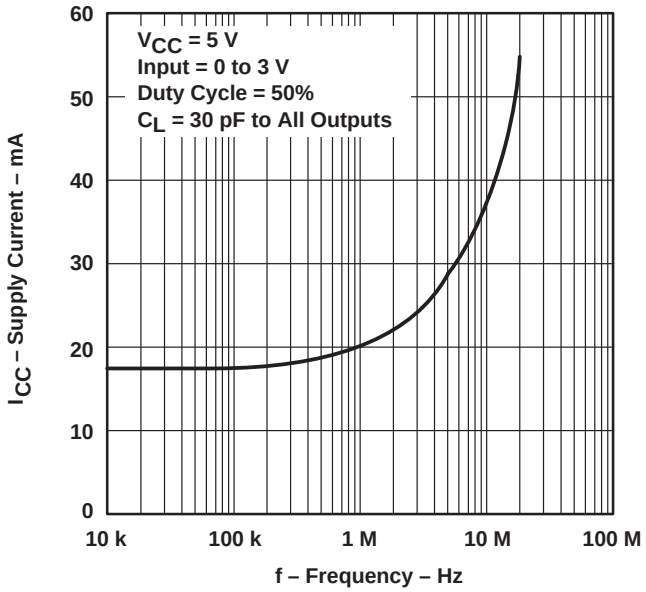


Figure 15

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